

# Conductor Mechanical Testing

*18 September 2012*

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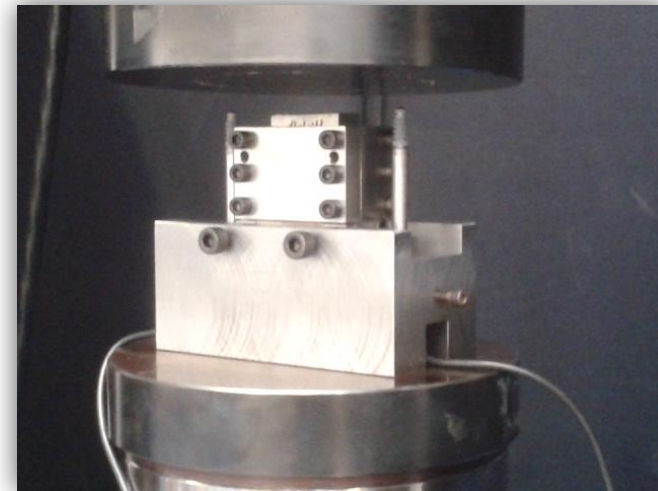
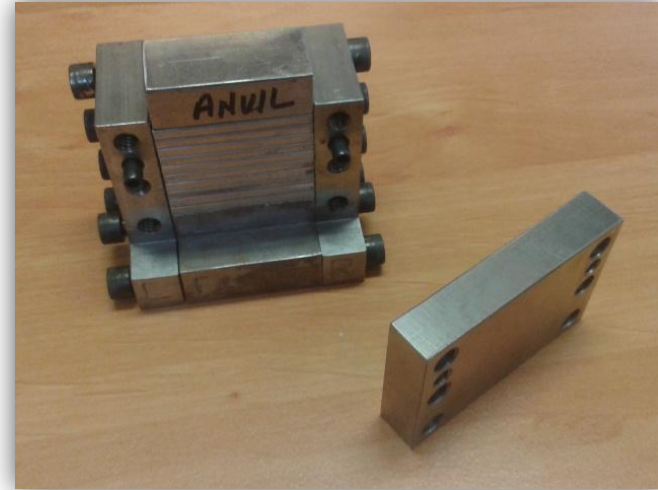
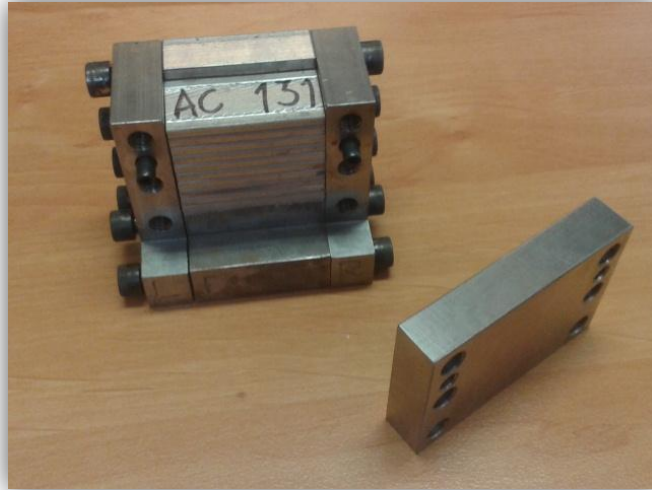
## Objectives

- Conductor samples and test fixture are provided by JLAB.
- The aim of this study is to check the influence of test fixture on results and of a preload at 15kN (20 MPa).
- Compression properties are compared to previous results (2012-09-05 Conductor testing UBS N°5).

## Conclusions

- Compression properties are identical to previous results.
- These new measurements still confirm the conductor must be consolidated according to the analysis and proposal made during the design review held at Sigmaphi on 12 July 2012.

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## ➤ MATERIALS AND METHODS

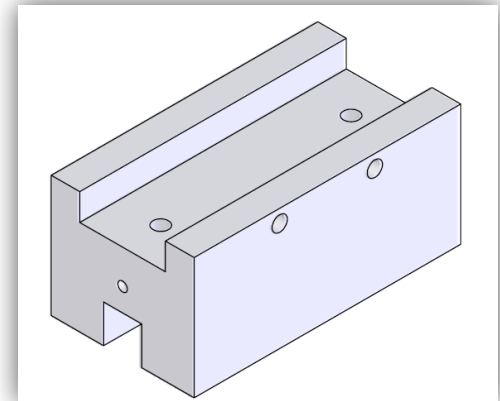
### Displacement measurements

- Direct measurements are impossible because of the assembly. Consequently mechanical probes are used in order to obtain an indirect measure.
- Displacement is given by the average of two probes measurements in order to eliminate ball pivot effects.
- These probes are mounted on an intermediate part to insure their verticality.



### Loading conditions

- Screws are tool tightened (contrary to JLAB's protocol).
- A Preload of 1kN is applied on the stack to set up 0% strain.
- A displacement speed of 0.01mm/s is imposed.
- Displacements are measured during 3 loads at 60kN (80 MPa).

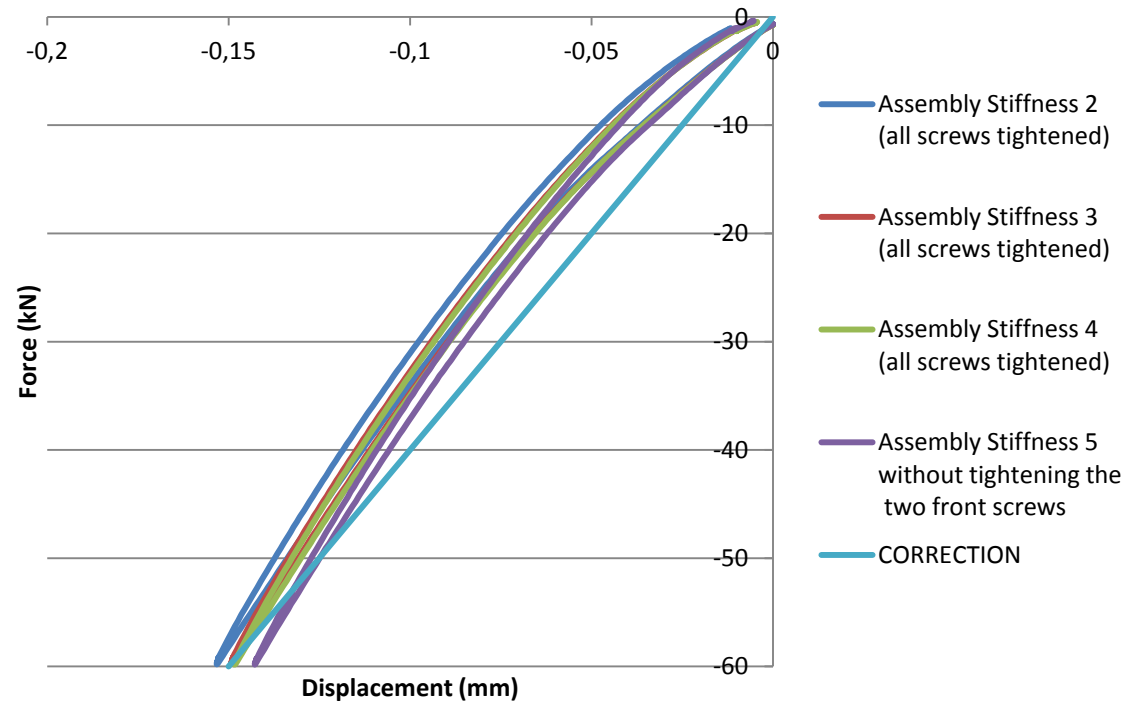


## ➤ MATERIALS AND METHODS

### Stiffness of the assembly

- Assembly will deform during test. Consequently we have to take into account its stiffness. Assembly displacement is measured four times as shown on this figure.
- We observe that this test is very repetitive and force as a function of displacement is quasi-linear.
- Consequently the stiffness of this assembly is of about 400kN/mm.
- This correction is negligible for a test on 10 layers but not for a test on a single layer.

**Correction to apply :  $D_{\text{real}} = D_{\text{measured}} - F/400$**



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## ➤ MATERIALS AND METHODS

### Measurements on 10 layers at 60kN without insulation

- AC 111, AC 121 and AC 131
- Top : Anvil / Bottom : no spacer

### Measurements on 10 layers at 15kN then 60kN without insulation

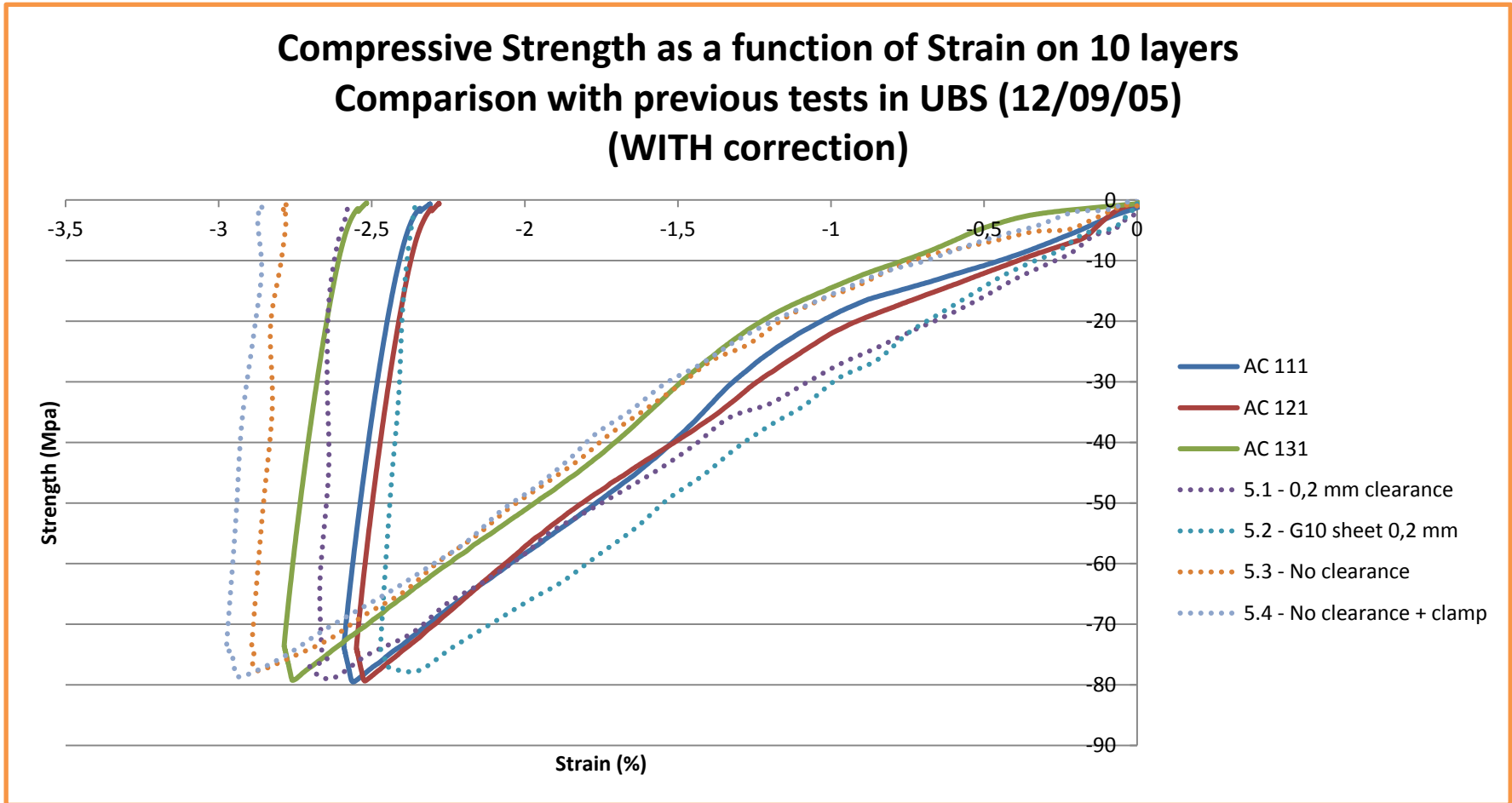
- BC 111, BC 121 and BC 131
- Top : Anvil / Bottom : no spacer

### Measurements on 10 layers at 15kN then 60kN WITH insulation

- BT 51 to BT 60
- Top : Anvil / Bottom : no spacer
- Insulation = Kapton + BStage

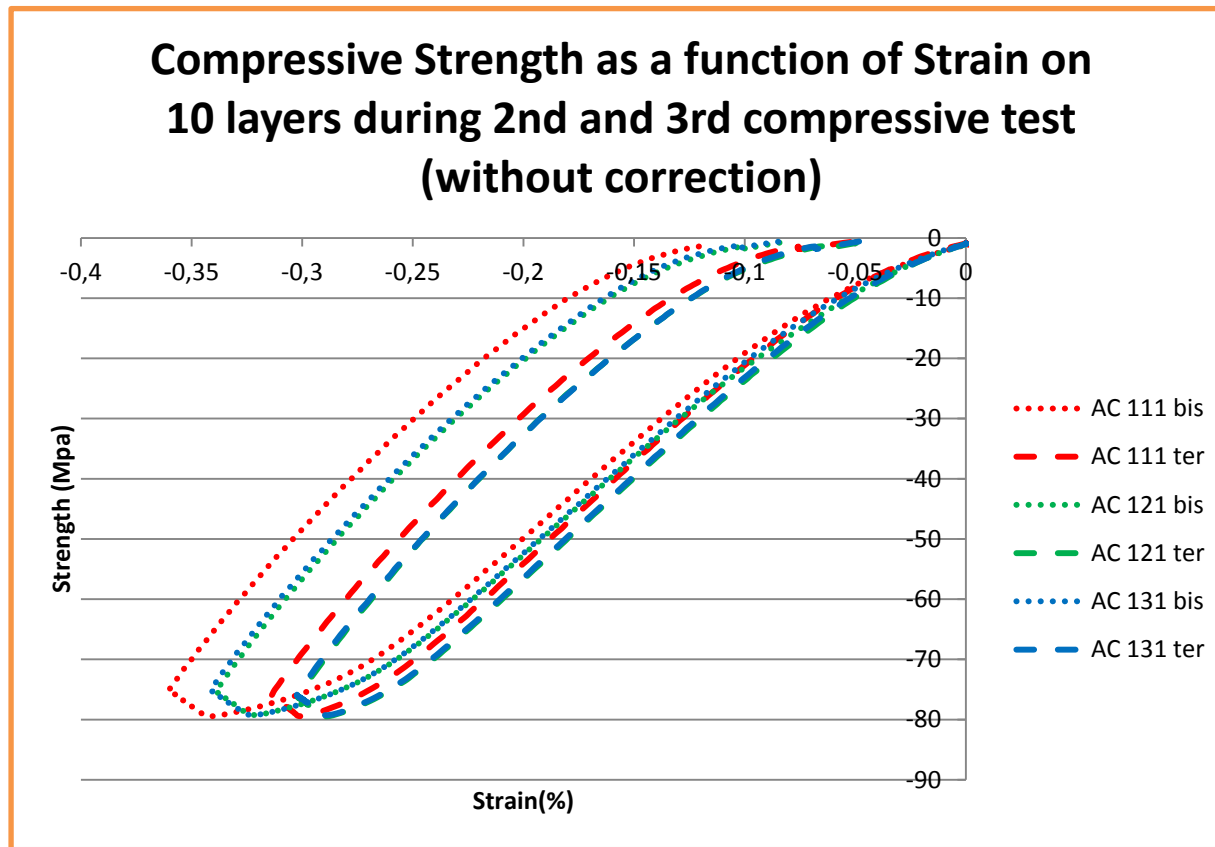
# Conductor Mechanical Testing

➤ 10 LAYERS AT 60kN without insulation



# Conductor Mechanical Testing

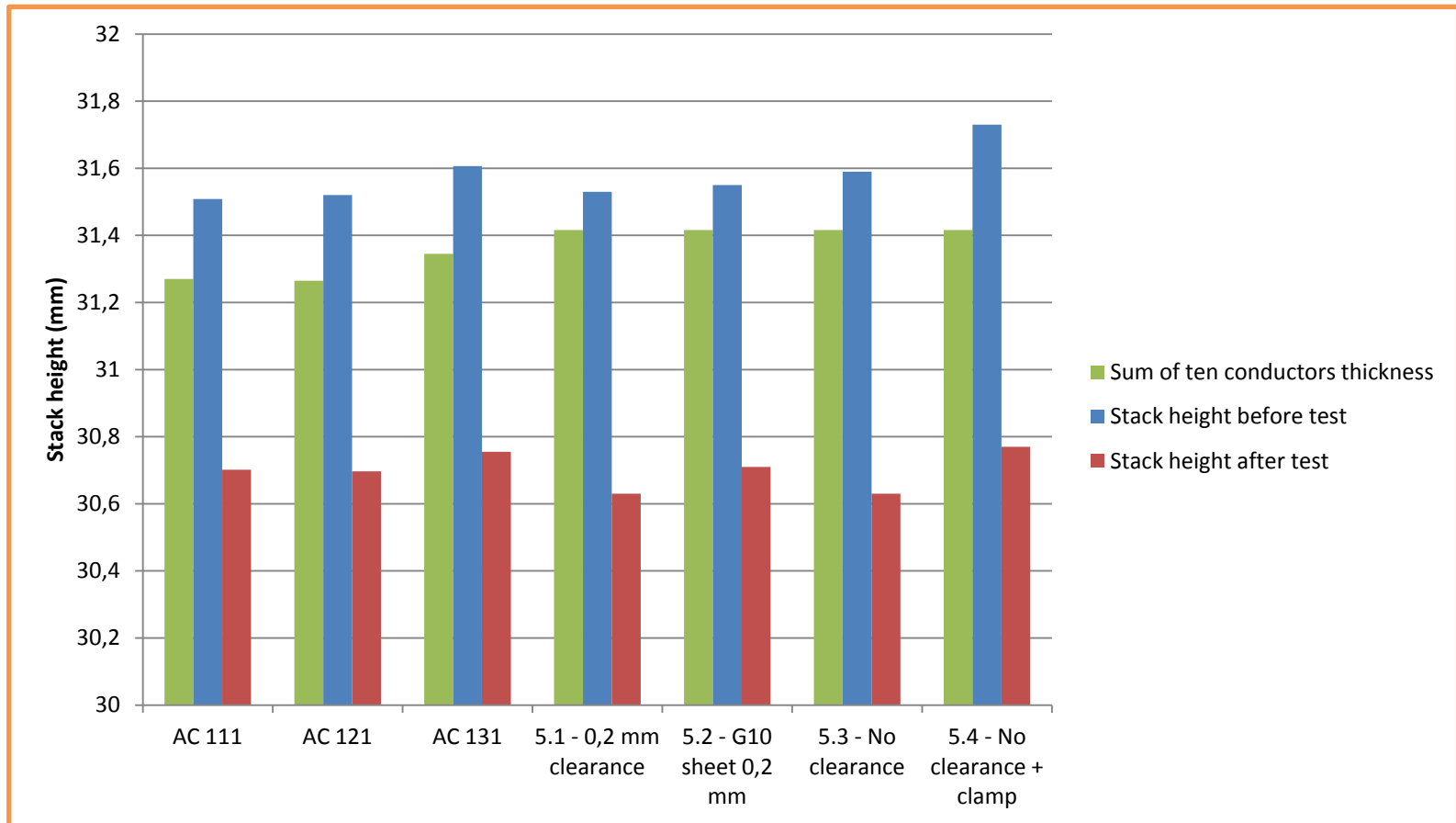
➤ 10 LAYERS AT 60kN without insulation





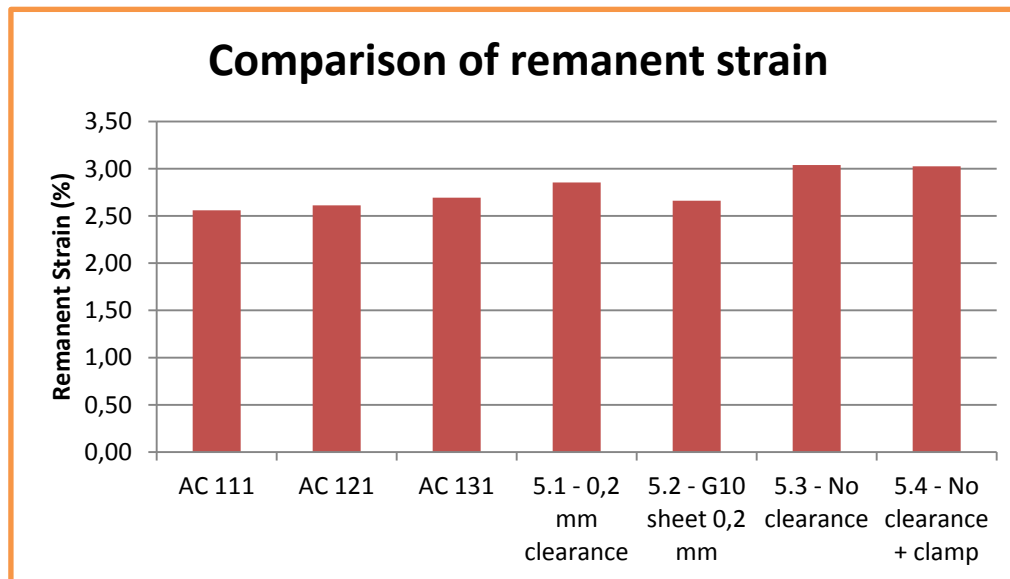
# Conductor Mechanical Testing

## ➤ 10 LAYERS AT 60kN without insulation



# Conductor Mechanical Testing

## ➤ 10 LAYERS AT 60kN without insulation

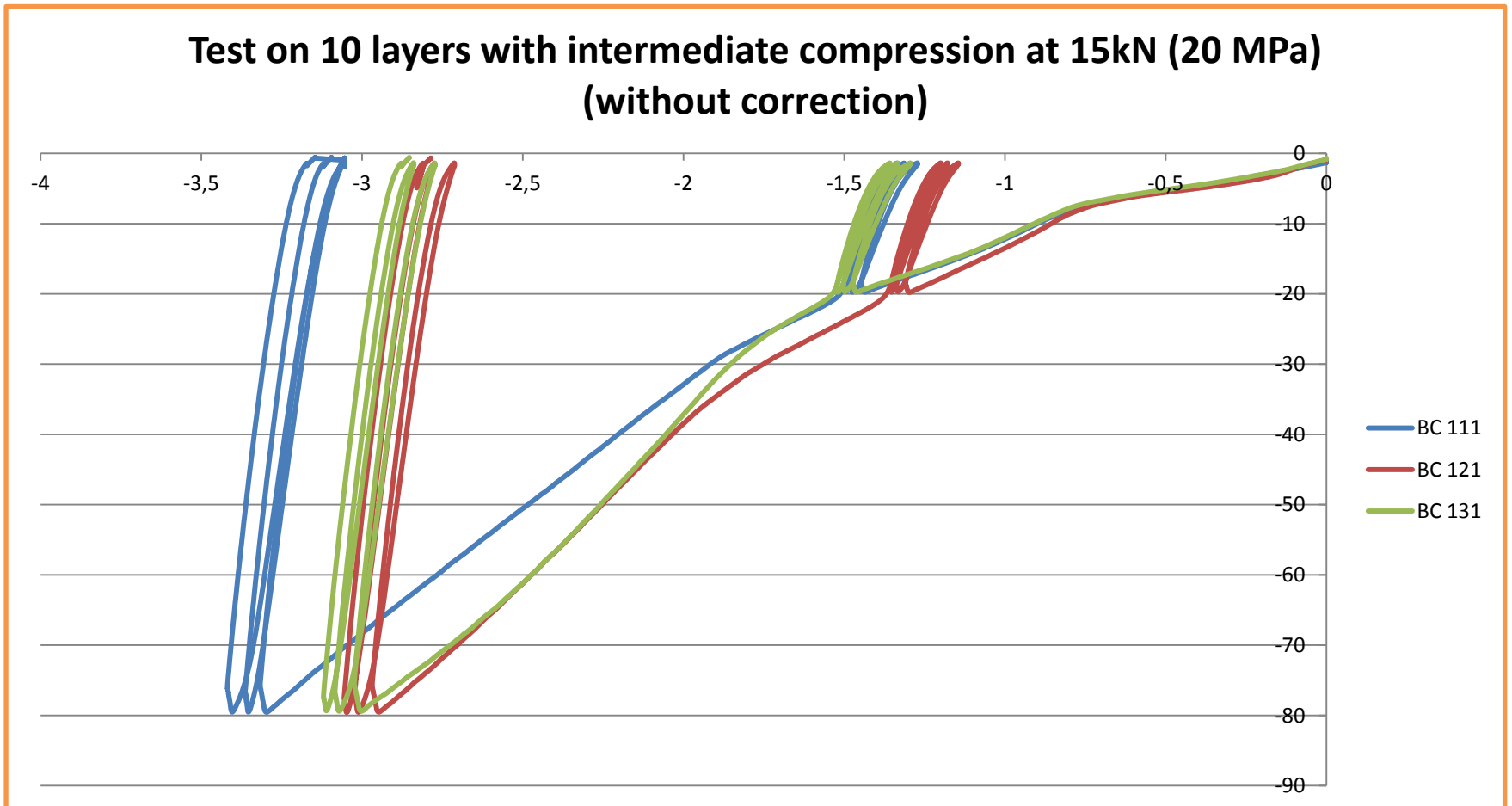


## CONCLUSIONS

- Compression properties are identical to previous results for a stack of ten layers.
- Test fixture has a negligible influence on stack strain.
- This implies that strain may occur preferentially into the conductor by filling the voids. It will be confirmed by tomography before and after compression test.

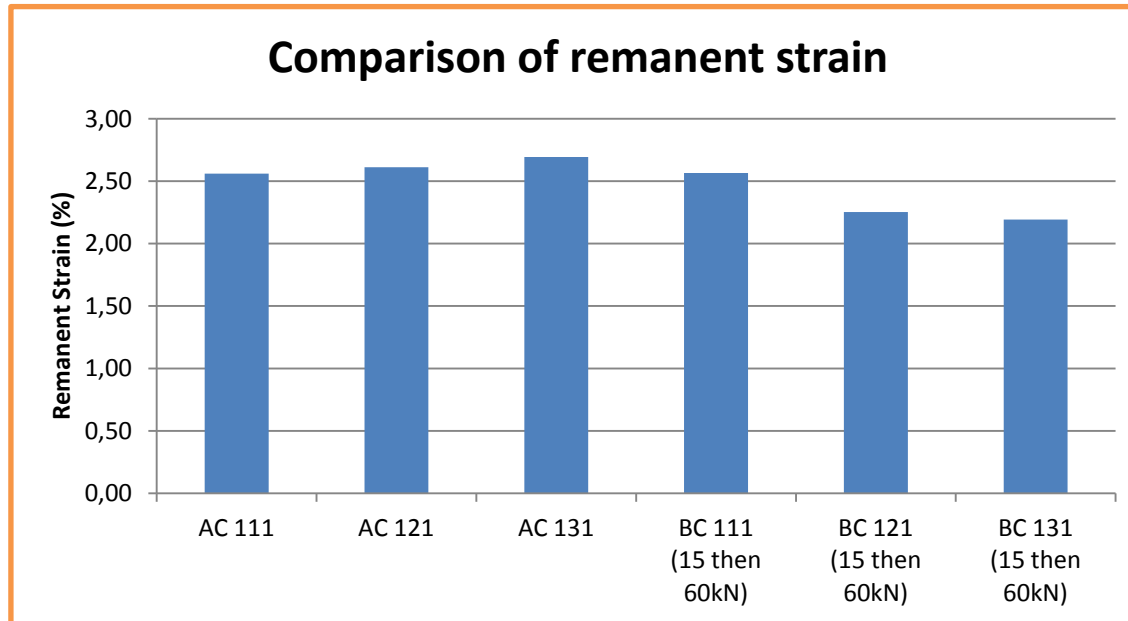
# Conductor Mechanical Testing

➤ 10 LAYERS AT 15 kN THEN 60kN without insulation



# Conductor Mechanical Testing

## ➤ 10 LAYERS AT 15 kN THEN 60kN without insulation

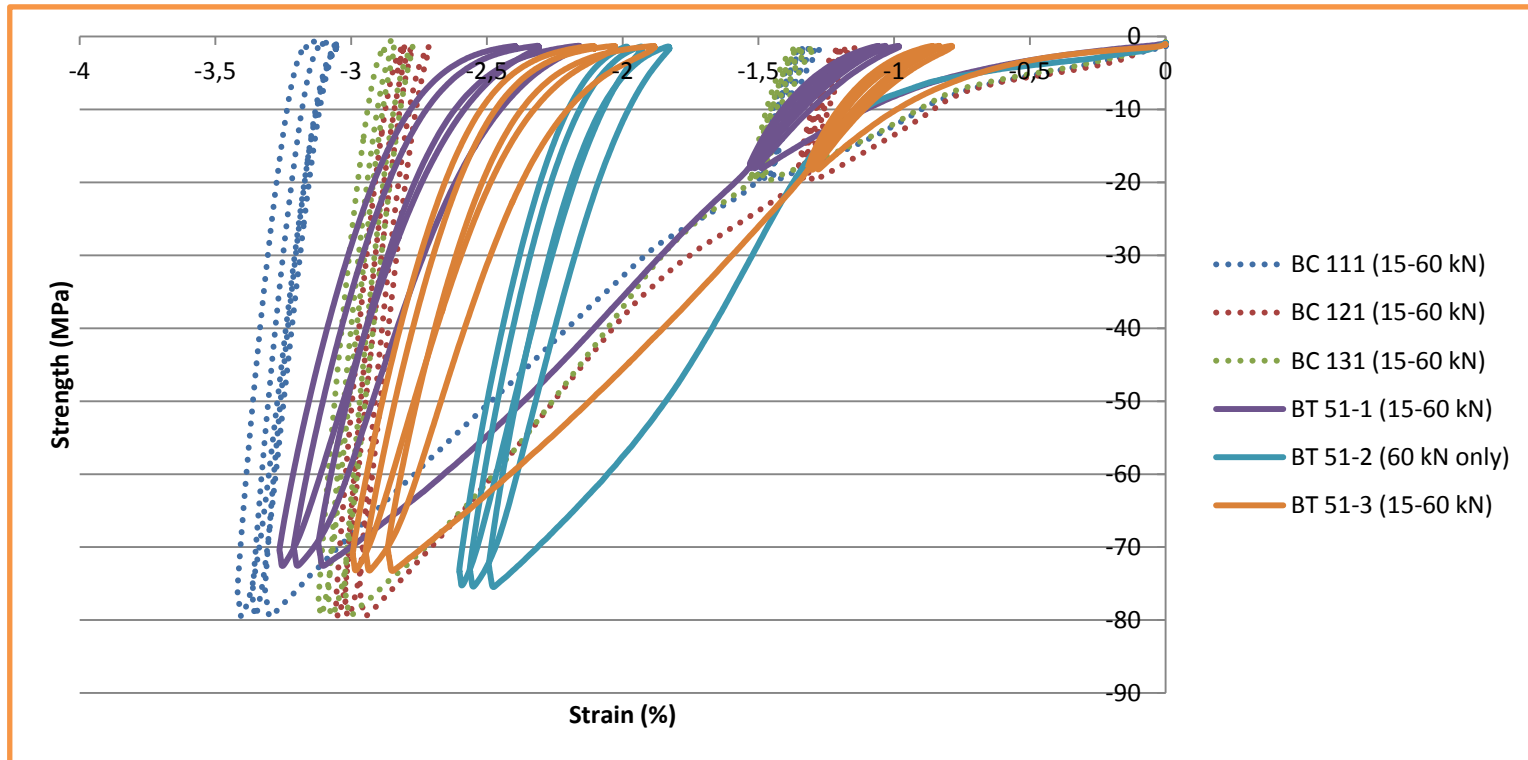


## CONCLUSIONS

- The preload at 15kN has no influence on stack stiffness.
- The stress-strain curve of the conductor is characteristic of a hardened material.
- The stress-strain curve has three gradients which may be caused by several types of voids.

# Conductor Mechanical Testing

- 10 LAYERS WITH insulation (BT 51-1 to 51-3)
- and WITHOUT insulation (BC 111 to BC 131)



## CONCLUSIONS

- Compression results are similar for conductors with and without insulation : there is no improvement of mechanical properties thanks to the insulation.